



EBS-P310W

Series

Embedded Computer

User Manual



This equipment is not suitable for use in locations where children are likely to be present.

E25963

First Edition

June 2025

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About this manual

This manual provides information about the hardware and software features of your Embedded Computer, organized through the following chapters:

Chapter 1: System introduction

This chapter details the hardware components of your Embedded Computer.

Chapter 2: Hardware setup

This chapter guides you through key setup procedures to get you started on using your Embedded Computer.

Chapter 3: Installing and upgrading key components

This chapter provides you with information on how to upgrade the memory modules, wireless modules, and hard disk drive / solid state drive of your Embedded Computer.

Chapter 4: Watchdog Timer

This chapter will guide you in implementing and programming the Watchdog Timer to allow you to monitor and manage system reliability.

Appendix

This section includes chassis dimensions, hardware specifications, safety statements, and regulatory notices for your Embedded Computer.

Conventions used in this manual

To highlight key information in this manual, some text are presented as follows:

IMPORTANT! This message contains vital information that must be followed to complete a task.

NOTE: This message contains additional information and tips that can help complete tasks.

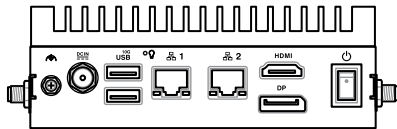
WARNING! This message contains important information that must be followed to keep you safe while performing certain tasks and prevent damage to your Embedded Computer's data and components.

1

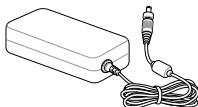
System introduction

1.1 Package contents

Your Embedded Computer package contains the following items:



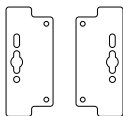
EBS-P310W Series



AC power adapter*

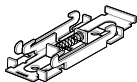


Power cord*

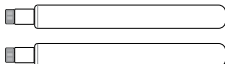


Wall mount kit

Optional item(s)



DIN rail clip



Cellular network antennas



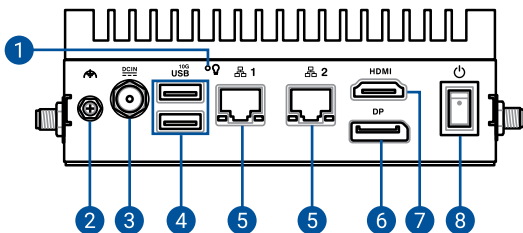
Wi-Fi antennas

NOTE:

- *The bundled power adapter and power cord may vary depending on model and country (or region) of sale.
 - Some bundled accessories may vary depending on model. For details on these accessories, refer to their respective user manuals.
 - The device illustration is for reference only. Actual product specifications may vary depending on model.
 - If the device or its components fail or malfunction during normal and proper use within the warranty period, bring the warranty card to the ASUS Service Center for replacement of the defective components.
-

1.2 System overview

1.2.1 Front view



1



System Power LED

The System Power LED lights up red when the system is connected to a power source and lights up green when it is powered on.

2



Functional Earth Ground

The Functional Earth Ground provides you with a grounding point.

3



Power input

The supplied power adapter converts AC power to DC power for use with this jack. Power supplied through this jack supplies power to the Embedded Computer.

WARNING! The power adapter may become warm to hot when in use. Do not cover the adapter and keep it away from your body.

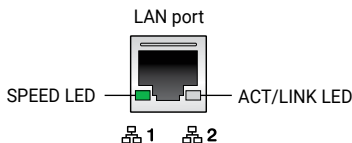
4 ^{10G} USB **USB 10Gbps port**

The USB (Universal Serial Bus) 10Gbps port provides a transfer rate up to 10 Gbit/s.

5 ¹ ² **LAN port**

The 8-pin RJ-45 LAN port supports a standard Ethernet cable for 10/100/1000/2500 Mbps connection to a local network.

LAN port LED indications



Activity Link LED	
Status	Description
Off	No link
Green	Linked
Green (blinking)	Data activity
Green (blinking then steady)	Ready to wake up from suspend mode

Speed LED	
Status	Description
Off	10/100 Mbps connection
Orange	1 Gbps connection
Green	2.5 Gbps connection

6

DP

DisplayPort

This DisplayPort 1.4 port can support resolutions up to 4096 x 2160 @ 60 Hz on external display devices.

7

HDMI

HDMI™ port

The HDMI (High Definition Multimedia Interface) 1.4 port can support resolutions up to 3840 x 2160 @ 30 Hz on external display devices.

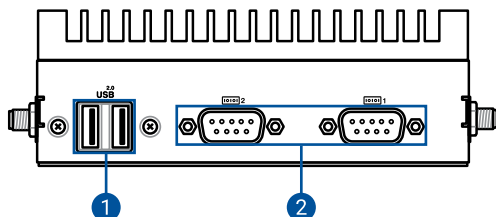
8



Power switch

The power switch allows you to turn the Embedded Computer on or off. You can use the power switch to put your Embedded Computer to sleep mode or press it for four (4) seconds to force shut down your Embedded Computer.

1.2.2 Rear view



1

2.0
USB

USB 2.0 port

The USB (Universal Serial Bus) port is compatible with USB 2.0 and USB 1.1 devices, such as keyboards, pointing devices, flash disk drives, external HDDs, speakers, cameras, and printers.

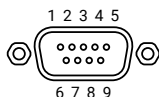
2

1
2

Serial (COM) connector

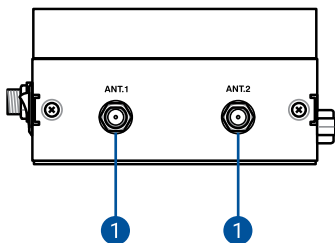
The 9-pin DB9 connector allows you to connect RS-232/422/485 serial (COM) devices, such as bar code scanners, modems, and printers. Please refer to the table below for the pin definitions of the different COM connectors.

NOTE: Default set to RS-232. Setting can be changed through the BIOS.



Pin	RS-232	RS-422	RS-485
1	NA	TX-	D-
2	RXD	TX+	D+
3	TXD	RX+	NA
4	NA	RX-	NA
5	GND	GND	GND
6	NA	NA	NA
7	RTS#	NA	NA
8	CTS#	NA	NA
9	NA	NA	NA

1.2.3 Right view

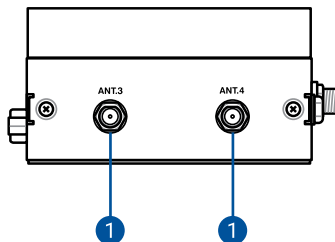


1

ANT. 1 **Antenna hole**

ANT. 2 The antenna hole allows you to connect a wireless antenna to enhance wireless signal reception.

1.2.4 Left view



1

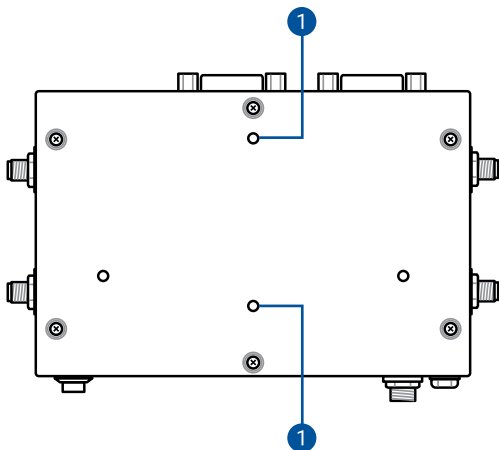
ANT. 3

Antenna hole

ANT. 4

The antenna hole allows you to connect a wireless antenna to enhance wireless signal reception.

1.2.5 Bottom view



1

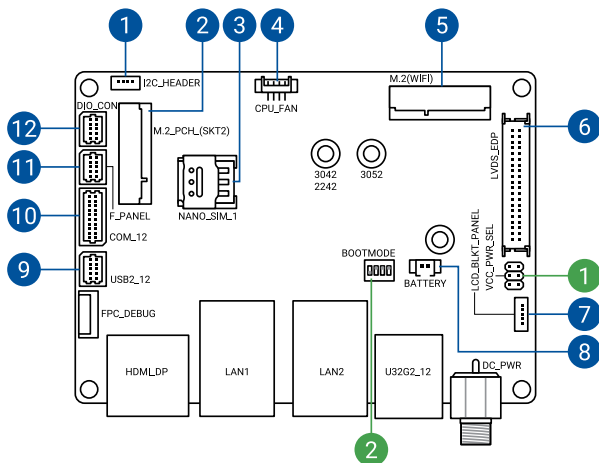
DIN rail clip mounting hole

The DIN rail clip mounting hole allows you to secure a DIN rail clip to your Embedded Computer, so you can attach it to a DIN rail system.

1.3 Motherboard overview

1.3.1 Motherboard layout

The EBS-P310W Series is an Embedded Computer based on a 2.5" motherboard (100 mm x 72 mm). Refer to the table on the next page for the names of the numbered items.



Jumpers/switches

- | | |
|----|--|
| 1. | Display Panel VCC Power Selection jumper |
| 2. | Boot Mode switch |

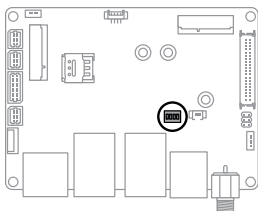
Connectors/slots

- | | |
|-----|------------------------------------|
| 1. | I ² C connector |
| 2. | M.2 (B-key) slot |
| 3. | Nano SIM Card slot |
| 4. | CPU Fan connector |
| 5. | M.2 (E-key) Wi-Fi slot |
| 6. | LVDS connector |
| 7. | Backlight Inverter Power connector |
| 8. | Battery connector |
| 9. | USB 2.0 connector |
| 10. | Serial Port connector |
| 11. | Front Panel connector |
| 12. | GPIO connector |

1.3.2 Onboard jumpers & switches

1. Boot Mode switch

The Boot Mode switch allows you to configure between different boot modes. Please refer to the table below for the different boot modes.



BOOTMODE

Clear CMOS setting



Disabled
(default)



Enabled

Auto power on setting



Disabled
(default)



Enabled

LVDS backlight setting



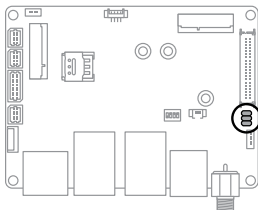
LVDS
backlight high
enabled
(default)



LVDS
backlight low
enabled

2. Display Panel VCC Power Selection jumper (on selected models)

The Display Panel VCC Power Selection jumper allows you to select the voltage for the LVDS panel.



VCC_PWR_SEL



3.3V
(Default)



5V

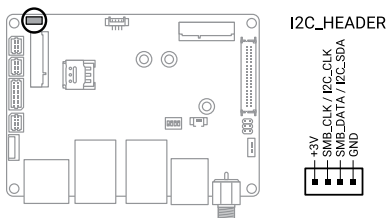


12V

1.3.3 Internal slots and connectors

1. I²C connector

The I²C (Inter-Integrated Circuit) connector allows you to connect an I²C-compatible IoT security module.

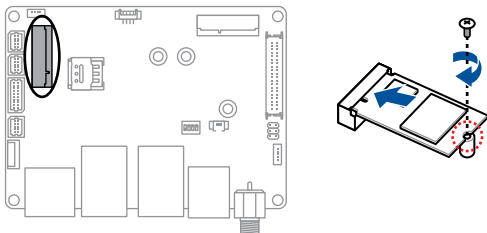


Connector type

Header 1x4p, K6, 1.0 mm pitch

2. M.2 (B-key) slot

The M.2 (B-key) slot allows you to install a B-key (SATA, USB 2.0, PCIe) type 2242/3042/3052 M.2 device, such as an M.2 SSD, 4G LTE module, or 5G NR module.

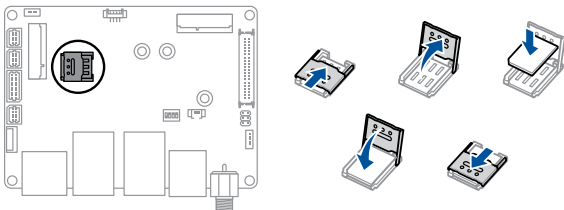


NOTE:

- The M.2 4G LTE or 5G NR module is purchased separately.
 - We recommend using a PH1 screwdriver with a torque of 2.0 ± 0.2 kgf-cm when tightening the screw.
-

3. Nano SIM Card slot

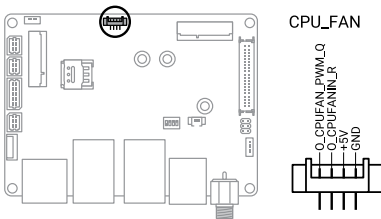
The Nano SIM Card slot allows you to install a Nano SIM card.



NOTE: The Nano SIM card is purchased separately.

4. CPU Fan connector

The fan connector allows you to connect a fan to actively cool the CPU.

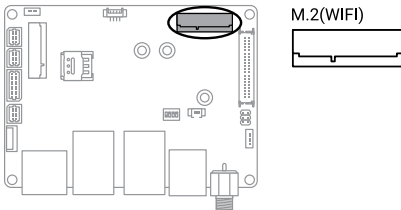


Connector type

WtoB 1x4p, 1.25 mm pitch

5. M.2 (E-key) Wi-Fi slot

The M.2 Wi-Fi slot allows you to install an M.2 Wi-Fi module (E-key, type 2230).

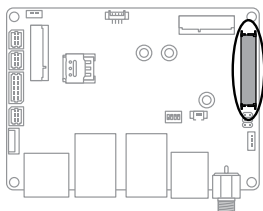


NOTE:

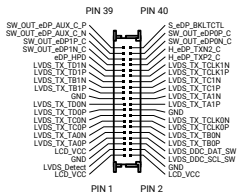
- The M.2 Wi-Fi module is purchased separately.
- We recommend using a PH1 screwdriver with a torque of 2.0 ± 0.2 kgf-cm when tightening the screw.

6. LVDS connector

The LVDS connector allows you to connect an LCD monitor that supports a Low-voltage Differential Signaling (LVDS) interface.



LVDS_EDP



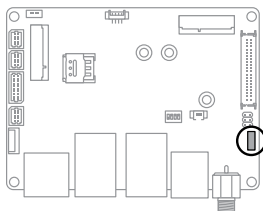
Connector type

WtoB 2x20p, 1.25 mm pitch

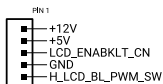
7. Backlight Inverter Power connector

The Backlight Inverter Power connector allows you to power the backlight inverter on a display panel via a backlight inverter module.

IMPORTANT! The Backlight Inverter Power connector supports a maximum current of 1.5 A.



LCD_BKLT_PANEL

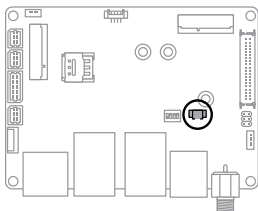


Connector type

Header 1x5p, K6, 1.0mm pitch

8. Battery connector

The Battery connector allows you to connect a lithium CMOS battery.

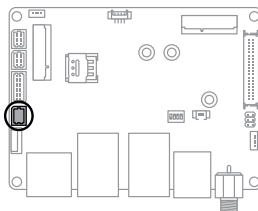


BATTERY

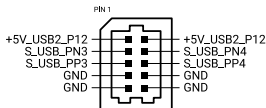


9. USB 2.0 connector

The USB 2.0 connector allows you to connect a USB module for additional USB 2.0 ports. The USB 2.0 connector provides data transfer speeds of up to 480 MB/s connection speed.



USB2_12



Connector type

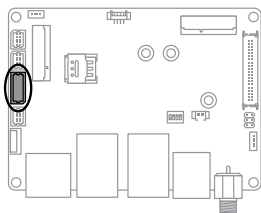
WtoB CON 2x5p 1.0 mm pitch, BLK S/T

WARNING! DO NOT connect a 1394 cable to the USB connectors. Doing so will damage the motherboard!

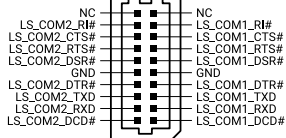
NOTE: The USB 2.0 module is purchased separately.

10. Serial Port connector

The Serial (COM) Port connector allows you to connect a serial port module. Connect the serial port module cable to this connector, then install the module to a slot opening on the system chassis.



COM_12



Connector type

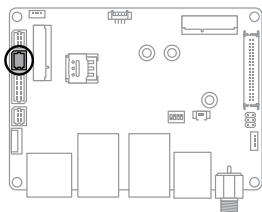
BOX header 2x10p, K10, 1.0 mm pitch

NOTE:

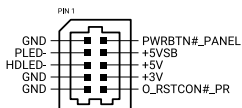
- The serial port module is purchased separately.
- **COM1** and **COM2** support RS-232/422/485.

11. System Panel connector

The System Panel connector supports several chassis-mounted functions.



F_PANEL



Connector type

WtoB CON 2x5p 1.0 mm pitch, BLK S/T

- **System Power LED connector (PLED)**

The 2-pin connector allow you to connect the System Power LED. System Power LED lights up when the system is connected to a power source or when you turn on the system power, blinks when the system is in S3 state, and turns off when in S4 or S5 state.

- **Power Button/Soft-off Button connector (PWRBTN)**

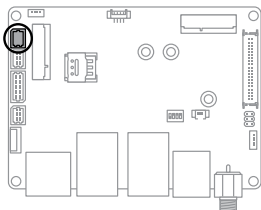
The 2-pin connector allows you to connect the system power button. Press the power button to power up the system, or put the system into sleep or soft-off mode (depending on the operating system settings).

- **Reset button connector (O_RSTCON)**

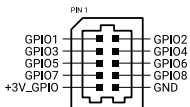
The 2-pin connector allows you to connect the chassis-mounted reset button. Press the reset button to reboot the system.

12. GPIO connector

The GPIO connector allows you to connect a general purpose input/output module to customize digital signal input/output.



DIO_CON



Connector type

WtoB CON 2x5p 1.0 mm pitch, BLK S/T

This image shows a single sheet of white paper with horizontal ruling lines. The lines are evenly spaced and run across the width of the page. There are no margins, text, or other markings on the paper.

2

Hardware setup

2.1 Getting started

2.1.1 Connect a display panel

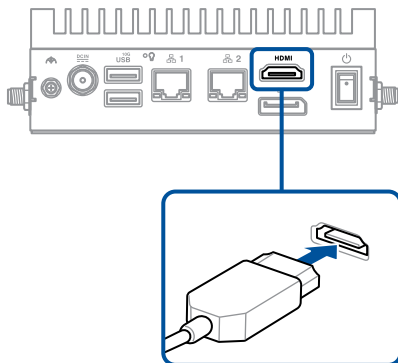
You can connect a display panel or projector to your Embedded Computer that has the following connectors:

- HDMI™ connector
- DisplayPort

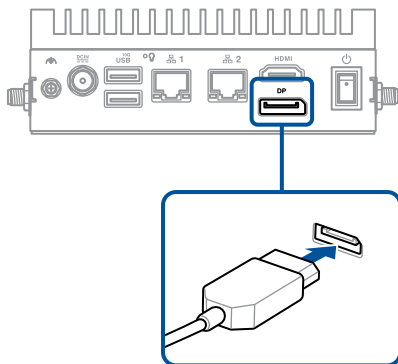
To connect a display panel to your Embedded Computer:

Connect one end of an HDMI™ or a DisplayPort cable to an external display, and the other end of the cable to your Embedded Computer's HDMI™ port or DisplayPort.

Connect display via HDMI™ port



Connect display via DisplayPort



2.1.2 Connect the USB cable from keyboard or mouse

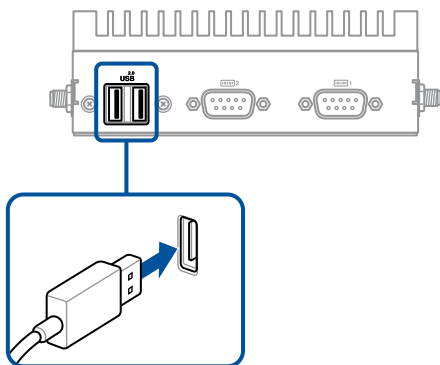
You can connect generally any USB keyboard and mouse to your Embedded Computer. You can also connect a USB dongle for a wireless keyboard and mouse set.

To connect a keyboard and mouse to your Embedded Computer:

Connect the USB cable from your keyboard and mouse to any of the USB ports of your Embedded Computer.

NOTE:

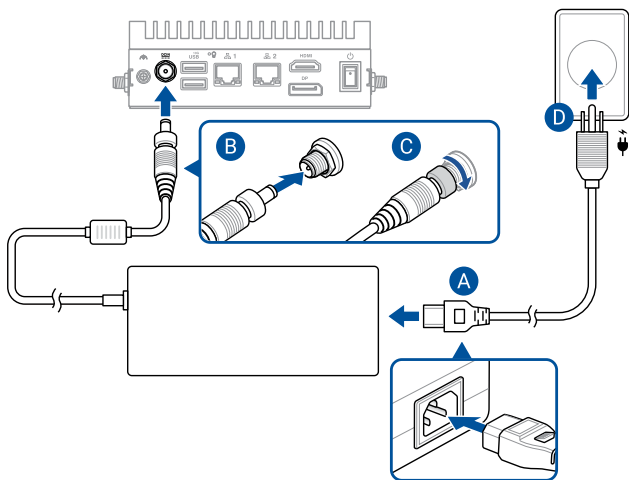
- The keyboard varies with country or region.
 - The keyboard and mouse are purchased separately.
-



2.1.3 Connect the AC power adapter to your Embedded Computer

To connect the AC power adapter to your Embedded Computer:

- Connect the power cord to the AC power adapter.
- Connect the DC power connector to your Embedded Computer's power (DC) input.
- (Optional) Tighten the locking ring to prevent disconnection caused by tension or vibration.
- Plug the AC power adapter into a 100 V - 240 V power source.



NOTE: The power adapter may vary in appearance, depending on model and country (or region) of sale. Refer to the following for more information on the different power adapters, as well as the system:

90 W Power adapter

- Input voltage: 100 - 240 Vac
- Input frequency: 50 - 60 Hz
- Output current: 7.5 A max (90 W)
- Output voltage: 12.0 Vdc
- Operating temperature: 0°C to 40°C

System

- Rated input current: 7.5 A (90 W)
 - Rated input voltage: 12.0 Vdc
 - Operating temperature: -20°C to 60°C
-

IMPORTANT!

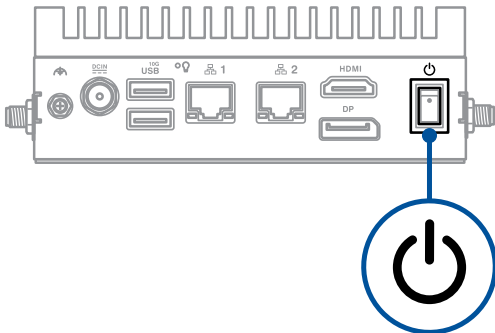
- We strongly recommend that you use only the AC power adapter and cable that came with your Embedded Computer.
 - We strongly recommend that you use a grounded wall socket while using your Embedded Computer.
 - The socket outlet must be easily accessible and near your Embedded Computer.
 - To disconnect your Embedded Computer from its main power supply, unplug your Embedded Computer from the power socket.
-

WARNING!

- Do not use power adapters or batteries from other devices to reduce the risk of injury to persons due to fire or explosion. Use only UL certified power adapters or batteries supplied by the manufacturer or authorized retailers.
 - Do not disable or remove the power cord grounding plug, the grounding is an important safety feature.
 - Ensure to plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
-

2.1.4 Turn on your Embedded Computer

Press the power switch to turn on your Embedded Computer.



2.2 Turning off your Embedded Computer

If your Embedded Computer is unresponsive, press and hold the power switch for at least four (4) seconds until your Embedded Computer turns off.

2.3 Putting your Embedded Computer to sleep

To put your Embedded Computer in Sleep mode, press the power switch once.

2.4 Entering the BIOS setup

BIOS (Basic Input and Output System) stores system hardware settings that are needed for system startup in the Embedded Computer.

In normal circumstances, the default BIOS settings apply to most conditions to ensure optimal performance. Do not change the default BIOS settings except in the following circumstances:

- An error message appears on the screen during the system bootup and requests you to run the BIOS setup.
- You have installed a new system component that requires further BIOS settings or update.

WARNING! Inappropriate BIOS settings may result to instability or boot failure. We strongly recommend that you change the BIOS settings only with the help of a trained service personnel.

Load default BIOS settings

To load the default values for each of the parameters in your BIOS:

1. Enter the BIOS by pressing <Delete> or <ESC> on the POST screen.

NOTE: POST (Power-On Self Test) is a series of software controlled diagnostic tests that run when you turn on your Embedded Computer.

2. Navigate to the Exit menu.
3. Select the Load Optimized Defaults option, or you may press <F3>.
4. Select OK to load the default BIOS values.

3

*Installing and upgrading
key components*

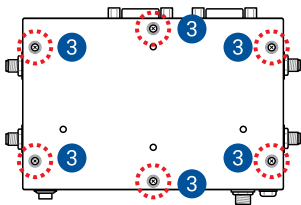
IMPORTANT!

- Ensure that your hands are dry before proceeding with the rest of the installation process. Before installing any of the features in this guide, use a grounded wrist strap or touch a safely grounded object or metal object to avoid damaging them due to static electricity.
 - Turn off the power of your Embedded Computer, and allow it to cool for at least 10 minutes before performing any installation/uninstallation process.
-

NOTE: The illustrations in this section are for reference only. The slots may vary depending on model.

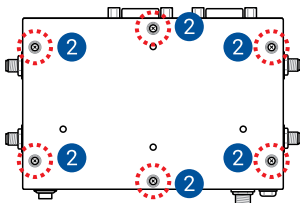
3.1 Removing the bottom cover

1. Turn off your Embedded Computer, then disconnect all cables and peripherals.
2. Place the Embedded Computer on a flat stable surface, with its top side facing down.
3. Remove the six (6) screws from the bottom cover.
4. Remove the bottom cover and place it aside.



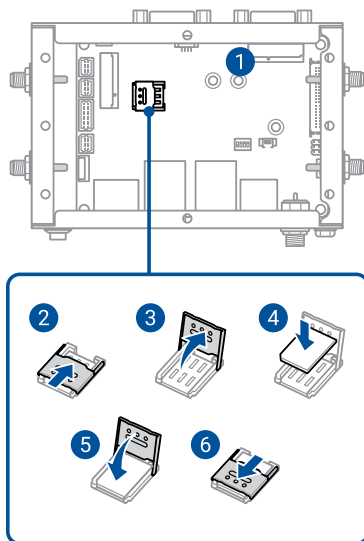
3.2 Replacing the bottom cover

1. Align the bottom cover with the screw holes, then replace the bottom cover onto the Embedded Computer.
2. Secure the bottom cover using the six (6) screws removed earlier.



3.3 Installing a nano SIM card

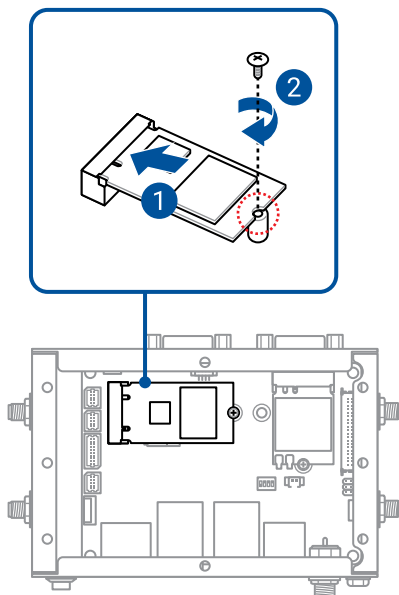
1. (Optional) Remove the M.2 module from the M.2 (B-key) slot, if one is installed, by first removing the screw securing the module, and then removing the module.
2. Push the nano SIM cover in the direction away from the M.2 B-key slot.
3. Lift the nano SIM cover.
4. Place the nano SIM into the nano SIM slot.
5. Close the nano SIM cover.
6. Push the nano SIM cover towards the M.2 B-key slot to secure the nano SIM card.



3.4 Installing an M.2 SSD to the M.2 (B-key) slot

1. Align and insert the M.2 SSD into the M.2 (B-key) slot inside the Embedded Computer.
2. Gently push down the M.2 SSD on top of the standoff and fasten it using a screw.

NOTE: We recommend using a PH1 screwdriver with a torque of 2.0 ± 0.2 kgf-cm when tightening the screw.



3.5 Installing a 4G LTE / 5G NR module to the M.2 (B-key) slot

WARNING! RF modules are intended for OEM or host integrators only. For availability of system level RF certification, check with your OEM integrator.

To install a 4G LTE module:

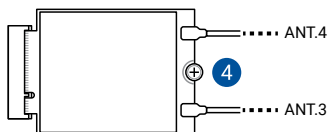
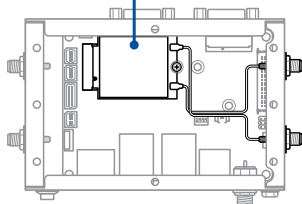
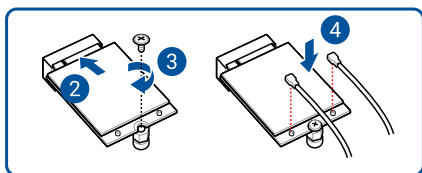
1. Remove the screw from the M.2 standoff.
 2. Align and insert the module into the slot.
 3. Press down, and then secure it in place using the screw removed earlier.
-

NOTE: We recommend using a PH1 screwdriver with a torque of 2.0 ± 0.2 kgf-cm when tightening the screw.

4. (Optional) Connect the RF cables from the antennas to your module. Make sure that the correct cable is attached to each of the connectors by referring to the illustration on the next page.
-

NOTE:

- Refer to **Installing antennas** for more information on installing the antennas.
 - Connecting antennas to your module may strengthen the signal.
 - A soft clicking sound indicates that the antenna has been securely attached on the module.
-



To install a 5G NR module:

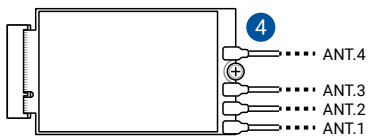
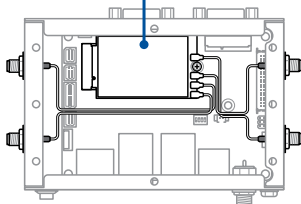
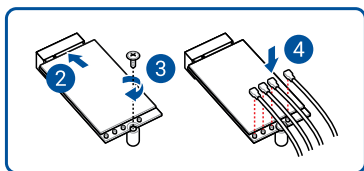
1. Remove the screw from the M.2 standoff.
2. Align and insert the module into the slot.
3. Press down, and then secure it in place using the screw removed earlier.

NOTE: We recommend using a PH1 screwdriver with a torque of 2.0 ± 0.2 kgf-cm when tightening the screw.

4. (Optional) Connect the RF cables from the antennas to your module. Make sure that the correct cable is attached to each of the connectors by referring to the illustration on the next page.

NOTE:

- Refer to **Installing antennas** for more information on installing the antennas.
 - Connecting antennas to your module may strengthen the signal.
 - A soft clicking sound indicates that the antenna has been securely attached to the module.
-



3.6 Installing a wireless card to the M.2 (E-key) slot

WARNING! RF modules are intended for OEM or host integrators only. For availability of system level RF certification, check with your OEM integrator.

1. Remove the M.2 screw.
2. Align and insert the wireless card into the M.2 (E-key) slot inside the Embedded Computer.
3. Gently push down the wireless card on top of the standoff, and then fasten it using the screw removed earlier.

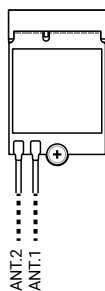
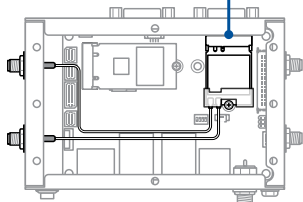
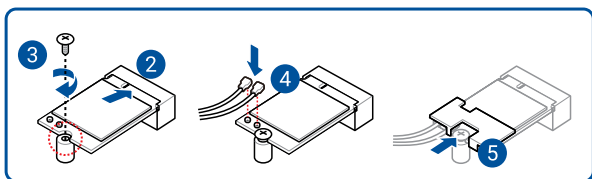
NOTE: We recommend using a PH1 screwdriver with a torque of 2.0 ± 0.2 kgf-cm when tightening the screw.

4. (Optional) Connect the RF cables from the antennas to your wireless card. Make sure that the correct cable is attached to each of the connectors by referring to the illustration on the next page.

NOTE:

- Please refer to the **Installing antennas** section for more information on installing the antennas.
 - Connecting antennas to your wireless card may strengthen the wireless signal.
 - A soft clicking sound indicates that the antenna has been securely attached on the wireless card.
-

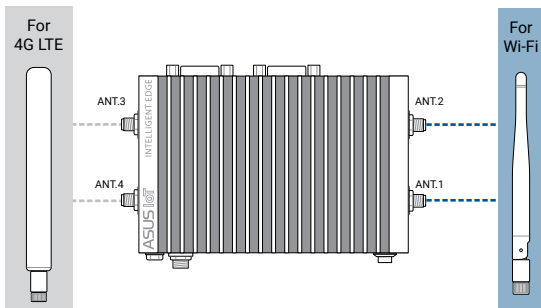
5. (Optional) Carefully slide the protective cover over the RF cables as shown.



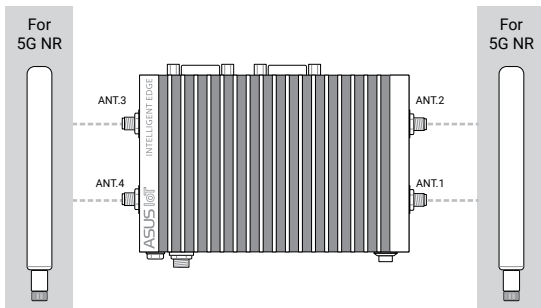
3.7 Installing antennas (optional)

You may install antennas to the antenna jacks located on the right and left panels. The installed antennas can be connected to a 4G LTE or 5G NR module installed in the M.2 B-key slot or to a wireless card installed in the M.2 E-key (Wi-Fi) slot.

4G module and wireless card



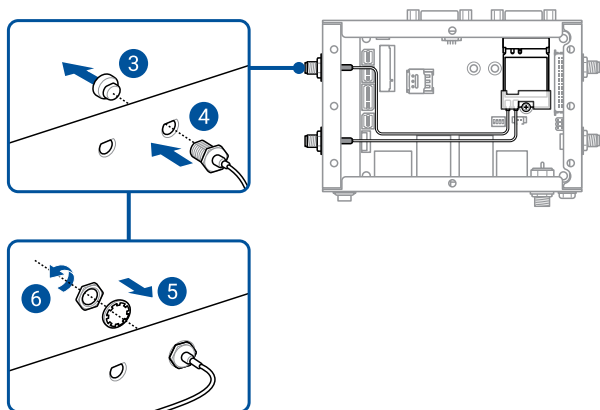
5G module



To install an antenna:

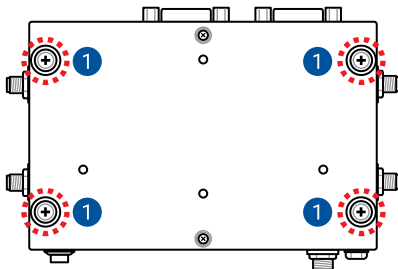
NOTE: If your Embedded Computer came pre-installed with wireless card antenna jacks, skip to step 8.

1. Remove the bottom cover. Refer to **Removing the bottom cover** for details.
2. Prepare the RF connector and cable.
3. Remove the rubber caps from the antenna holes.
4. Insert the antenna jack end of the RF connector and cable into the antenna hole from within the chassis outwards, ensuring that the flat edge of the jack is properly aligned to the flat edge of the hole.
5. Insert the bundled O-ring over the antenna jack.
6. Secure the antenna jack using one of the bundled hex screws.
7. Connect the other end of the RF connector and cable to your wireless card (refer to **Installing a wireless card to the M.2 (E-key) slot** for details) or to your 4G LTE / 5G NR module (refer to **Installing a 4G LTE / 5G NR module to the M.2 (B-key) module** for details).
8. Replace the bottom cover. Refer to **Replacing the bottom cover** for details.
9. Screw the external Wi-Fi antennas onto their corresponding antenna jacks on the front and rear panels by turning them in a clockwise direction.
10. Position the antennas for optimal signal reception.

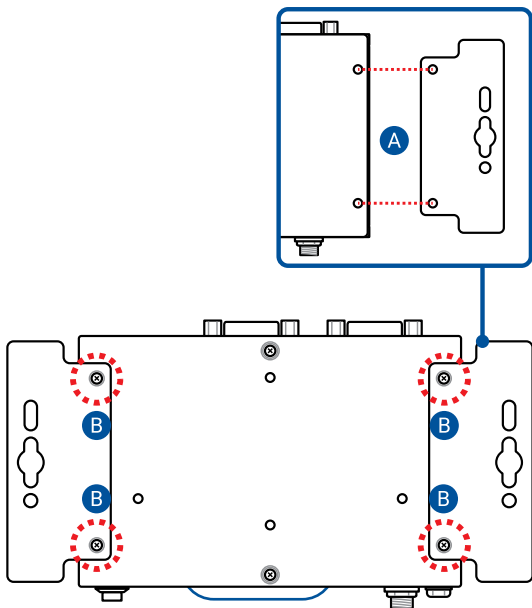


3.8 Installing wall mount brackets (optional)

1. Remove the four (4) screws from the bottom cover.



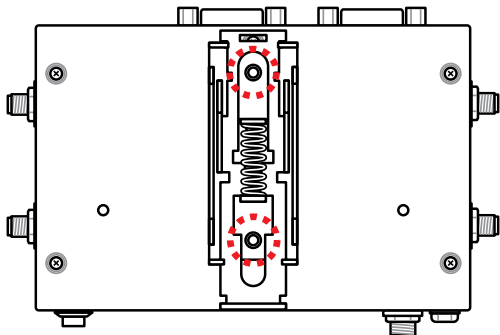
2. Align the wall mount with the bottom cover screw holes (A), and then secure the wall mount brackets to your Embedded Computer using the screws removed earlier (B).



NOTE: The bottom cover and wall mount screws are the same screws.

3.9 Installing a DIN rail clip (optional)

1. Align the screw holes on the DIN rail clip to your Embedded Computer's bottom cover.
2. Secure the DIN rail clip to the bottom cover using the screws bundled with the DIN rail clip.



3. Clip the final assembly to a DIN rail by hooking the DIN rail clips to the top of the DIN rail and then pressing down until you hear the clip snap into place.

4

Watchdog Timer

4.1 Watchdog Timer implementation

There are two watchdog timer implementations designed on this product, the HW and POST watchdog timers. The watchdog timer circuit is in SuperIO and can be controlled by a hardware jumper and BIOS setup menu through the system BIOS for different boot phases.

Please refer to the table below for the different implementations of the Watchdog Timer.

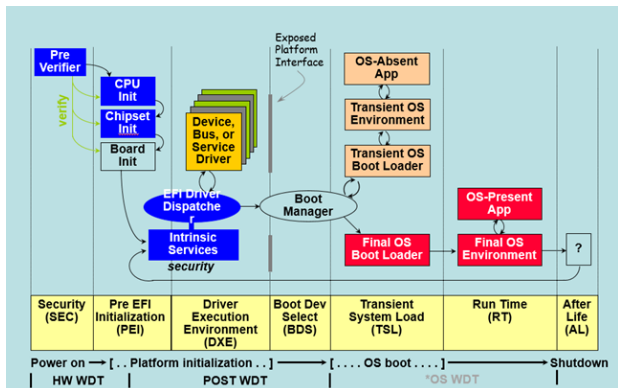
Watchdog timer	Implementation	Default Timeout
HW Watchdog Timer	This Watchdog Timer can prevent the system from failing before BIOS takeover. After the system is powered on, the watchdog timer will start automatically through the jumper setting.	6 seconds.
	NOTE: - Refer to the HW WDT enable jumper in the section Motherboard Overview for more information. - The default setting for this jumper is set to HW WDT enabled with a jumper cap attached.	

(continued on the next page)

Watchdog timer	Implementation	Default Timeout
POST Watchdog Timer	This Watchdog Timer is for recovering the system from crashes during BIOS takeover to OS. After system BIOS takeover, the BIOS will stop the HW watchdog timer and start the POST watchdog timer on the same hardware watchdog circuit. NOTE: The default setting for the BIOS item is set to enabled.	The timeout value is determined by the BIOS settings.
*OS Watchdog Timer	No implementation. User needs to write software in OS to keep updating the watchdog timer to prevent it from timing out. The application is executed on payload. NOTE: Please refer to the section Watchdog Timer Programming for more information.	N/A

4.2 Watchdog Timer flowchart

Please refer to the Watchdog Timer initialization flowchart below:



4.3 Watchdog Timer programming

Please refer to the pseudo code for the NCT6116D watchdog timer programming below:

SIO_INDEX_PORT is 0x2E

SIO_DATA_PORT is 0x2F

1. Set WDT Time Unit

```
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO

Outportb(SIO_INDEX_PORT, 0x07);
Outportb(SIO_DATA_PORT, 0x08);
Outportb(SIO_INDEX_PORT, 0xF0);
val = Inportb(SIO_DATA_PORT) // Read current WDT setting

val = val | 0x08; // minute mode, val = val & 0xF7 if second mode
Outportb(SIO_INDEX_PORT, 0xF0);
Outportb(SIO_DATA_PORT, val); // Write back WDT setting

Outportb(SIO_INDEX_PORT, 0xAA); // Lock SIO
```

2. Set WDT Time

```
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO

Outportb(SIO_INDEX_PORT, 0x07);
Outportb(SIO_DATA_PORT, 0x08);
Outportb(SIO_INDEX_PORT, 0xF1);
Outportb(SIO_DATA_PORT, Time); // Write WDT time, value 1 to 255

Outportb(SIO_INDEX_PORT, 0xAA); // Lock SIO
```

3. Enable WDT

```
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO

Outportb(SIO_INDEX_PORT, 0x07);
Outportb(SIO_DATA_PORT, 0x08);
Outportb(SIO_INDEX_PORT, 0x30);
val = Inportb(SIO_DATA_PORT) // Read current WDT status

val = val | 0x01; // Enable WDT Timer
Outportb(SIO_INDEX_PORT, 0x30);
Outportb(SIO_DATA_PORT, val); // Write back WDT status

Outportb(SIO_INDEX_PORT, 0xAA); // Lock SIO
```

4. Disable WDT

```
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO
Outportb(SIO_INDEX_PORT, 0x87); // Unlock SIO

Outportb(SIO_INDEX_PORT, 0x07);
Outportb(SIO_DATA_PORT, 0x08);
Outportb(SIO_INDEX_PORT, 0xF1);
Outportb(SIO_DATA_PORT, 0x00); // Clear WDT time, it means WDT
Time-Out disable

Outportb(SIO_INDEX_PORT, 0x30);

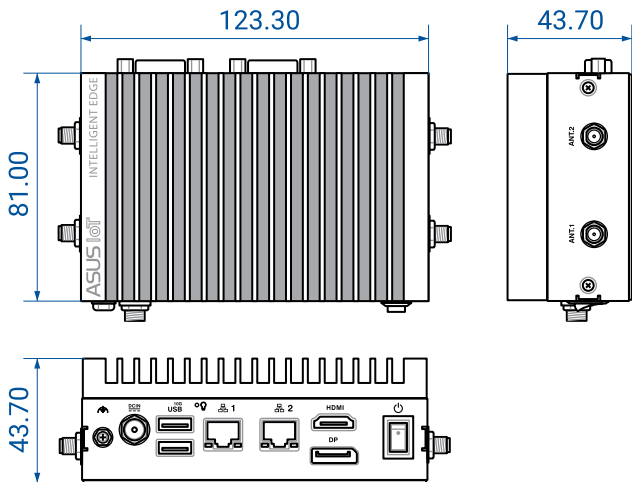
val = Inportb(SIO_DATA_PORT) // Read current WDT status
val = val & 0xFE; // Disable WDT Timer
Outportb(SIO_INDEX_PORT, 0x30);
Outportb(SIO_DATA_PORT, val); // Write back WDT status

Outportb(SIO_INDEX_PORT, 0xAA); // Lock SIO
```

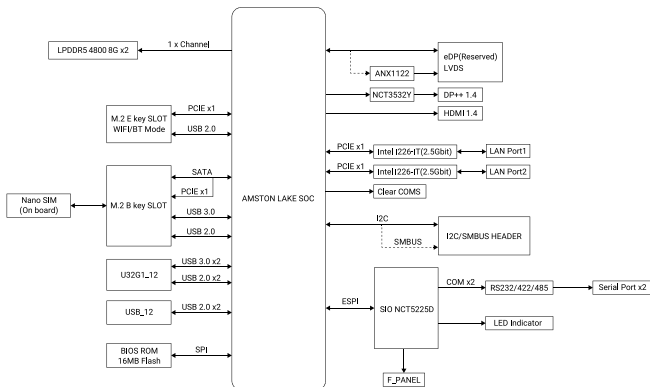
This image shows a single sheet of white paper with horizontal ruling lines. The lines are evenly spaced and run across the width of the page. There are no margins, text, or other markings on the paper.

Appendix

A.1 Chassis dimensions



A.2 Block diagram



A.3 Safety information

Your Embedded Computer is designed and tested to meet the latest standards of safety for information technology equipment. However, to ensure your safety, it is important that you read the following safety instructions.

A.3.1 Setting up your system

- Read and follow all instructions in the documentation before you operate your system.
- Do not use this product near water or a heated source.
- Set up the system on a stable surface.
- Peripherals with extended tolerance (such as industrial grade mSATA and micro SD card) will allow this product to be used in environments with ambient temperatures between 0°C and 60°C with adequate airflow.
- The product should be used in environments with an ambient temperature of 60°C when using the 90 W power adapter.
- If you use an extension cord, make sure that the total ampere rating of the devices plugged into the extension cord does not exceed its ampere rating.
- This equipment should be installed and operated with a minimum distance of 20 cm between the radiator and your body.
- This device shall not be connected to an Ethernet network with outside plant routing.

A.3.2 Care during use

- Do not walk on the power cord or allow anything to rest on it.
- Do not spill water or any other liquids on your system.
- When the system is turned off, a small amount of electrical current still flows. Always unplug the power cord from the power outlets before cleaning the system.
- If you encounter the following technical problems with the product, unplug the power cord and contact a qualified service technician or your retailer.
 - The power cord or plug is damaged.
 - Liquid has been spilled into the system.
 - The system does not function properly even if you follow the operating instructions.
 - The system was dropped or the cabinet is damaged.
 - The system performance changes.

Safety precautions

Accessories that came with this product have been designed and verified for the use in connection with this product. Never use accessories for other products to prevent the risk of electric shock or fire.

Lithium-Metal Battery Warning

CAUTION: Danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions.

NO DISASSEMBLY

The warranty does not apply to the products that have been disassembled by users

A.4 Regulatory notices

COATING NOTICE

IMPORTANT! To provide electrical insulation and maintain electrical safety, a coating is applied to insulate the device except on the areas where the I/O ports are located.

Federal Communications Commission Statement

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- This device may not cause harmful interference, and
- This device must accept any interference received including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment.

This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

IMPORTANT! Outdoor operations in the 5.15~5.25 GHz band is prohibited. This device has no Ad-hoc capability for 5250~5350 and 5470~5725 MHz.

CAUTION! Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC RF Exposure Information

This device meets the government's requirements for exposure to radio waves. This device is designed and manufactured not to exceed the emission limits for exposure to radio frequency (RF) energy set by the Federal Communications Commission of the U.S. Government. The exposure standard employs a unit of measurement known as the Specific Absorption Rate, or SAR. The SAR limit set by the FCC is 1.6 W/kg. Tests for SAR are conducted using standard operating positions accepted by the FCC with the EUT transmitting at the specified power level in different channels. The FCC has granted an Equipment Authorization for this device with all reported SAR levels evaluated as in compliance with the FCC RF exposure guidelines. SAR information on this device is on file with the FCC and can be found under the Display Grant section of www.fcc.gov/oet/ea/fccid.

FCC 5.925-7.125 GHz Caution Statement

Operation of transmitters in the 5.925-7.125 GHz band is prohibited for control of or communications with unmanned aircraft systems.

End Product Labeling

This transmitter module is authorized only for use in device where the antenna may be installed such that 20 cm may be maintained between the antenna and users.

ISED Radiation Exposure Statement for Canada

This equipment complies with ISED radiation exposure limits set forth for an uncontrolled environment. To maintain compliance with ISED RF exposure compliance requirements, please avoid direct contact to the transmitting antenna during transmitting. End users must follow the specific operating instructions for satisfying RF exposure compliance.

Operation is subject to the following two conditions:

- This device may not cause interference and
- This device must accept any interference, including interference that may cause undesired operation of the device.

Compliance Statement of Innovation, Science and Economic Development Canada (ISED)

This device complies with Innovation, Science and Economic Development Canada licence exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

CAN ICES(B)/NMB(B)

Déclaration de conformité de Innovation, Sciences et Développement économique Canada (ISED)

Le présent appareil est conforme aux CNR d'Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

CAN ICES(B)/NMB(B)

ISED 5.925-7.125 GHz Caution Statement

RLAN devices:

- Devices shall not be used for control of or communications with unmanned aircraft systems.
- Devices shall not be used on oil platforms.
- Devices shall not be used on aircraft, except for the low-power indoor access points, indoor subordinate devices, low-power client devices, and very low-power devices operating in the 5925-6425 MHz band, that may be used on large aircraft as defined in the Canadian Aviation Regulations, while flying above 3,048 metres (10,000 feet).
- Devices shall not be used on automobiles.
- Devices shall not be used on trains.
- Devices shall not be used on maritime vessels.
- Les dispositifs ne doivent pas être utilisés pour commander des systèmes d'aéronef sans pilote ni pour communiquer avec de tels systèmes;
- Les dispositifs ne doivent pas être utilisés sur les plateformes de forage pétrolier;
- Les dispositifs ne doivent pas être utilisés dans les aéronefs, à l'exception des points d'accès intérieurs de faible puissance, des dispositifs subordonnés intérieurs, des dispositifs clients de faible puissance et des dispositifs de très faible puissance fonctionnant dans la bande de 5 925 à 6 425 MHz, qui peuvent être utilisés dans les gros aéronefs tel qu'il est défini dans le Règlement de l'aviation canadien, et ce, lorsqu'ils volent à une altitude supérieure à 3 048 mètres (10 000 pieds).
- Les dispositifs ne doivent pas être utilisés dans les automobiles;
- Les dispositifs ne doivent pas être utilisés dans les trains;
- Les dispositifs ne doivent pas être utilisés sur les navires maritimes.

Wireless Operation Channel for Different Domains

N. America	2.412-2.462 GHz	Ch01 through CH11
Japan	2.412-2.484 GHz	Ch01 through Ch14
Europe ETSI	2.412-2.472 GHz	Ch01 through Ch13

Japan RF Equipment Statement

屋外での使用について

本製品は、5GHz帯域での通信に対応しています。電波法の定めにより5.2GHz、5.3GHz、及び6GHz帯域の電波は屋外で使用が禁じられています。

法律および規制遵守

本製品は電波法及びこれに基づく命令の定めるところに従い使用してください。日本国外では、その国の法律または規制により、本製品の使用ができないことがあります。このような国では、本製品を運用した結果、罰せられることがあります。当社は一切責任を負いかねますのでご了承ください。

RF Module Warning Statement

RF modules are intended for OEM or host integrators only. For availability of system level RF certification, check with your OEM integrator.

Declaration of compliance for product environmental regulation

ASUS follows the green design concept to design and manufacture our products, and makes sure that each stage of the product life cycle of ASUS product is in line with global environmental regulations. In addition, ASUS disclose the relevant information based on regulation requirements.

Please refer to <https://esg.asus.com/Compliance.htm> for information disclosure based on regulation requirements ASUS is complied with.

EU REACH and Article 33

Complying with the REACH (Registration, Evaluation, Authorization, and Restriction of Chemicals) regulatory framework, we publish the chemical substances in our products at ASUS REACH website at <https://esg.asus.com/Compliance.htm>

EU RoHS

This product complies with the EU RoHS Directive. For more details, see <https://esg.asus.com/Compliance.htm>

Japan JIS-C-0950 Material Declarations

Information on Japan RoHS (JIS-C-0950) chemical disclosures is available on <https://esg.asus.com/Compliance.htm>

India RoHS

This product complies with the “India E-Waste (Management) Rules, 2016” and prohibits use of lead, mercury, hexavalent chromium, polybrominated biphenyls (PBBs) and polybrominated diphenyl ethers (PBDEs) in concentrations exceeding 0.1% by weight in homogenous materials and 0.01% by weight in homogenous materials for cadmium, except for the exemptions listed in Schedule II of the Rule.

Vietnam RoHS

ASUS products sold in Vietnam, on or after September 23, 2011, meet the requirements of the Vietnam Circular 30/2011/TT-BCT.

Các sản phẩm ASUS bán tại Việt Nam, vào ngày 23 tháng 9 năm 2011 trở về sau, đều phải đáp ứng các yêu cầu của Thông tư 30/2011/TT-BCT của Việt Nam.

Türkiye RoHS

AEEE Yönetmeliğine Uygundur

ASUS Recycling/Takeback Services

ASUS recycling and takeback programs come from our commitment to the highest standards for protecting our environment. We believe in providing solutions for you to be able to responsibly recycle our products, batteries, other components as well as the packaging materials. Please go to <https://esg.asus.com/en/Takeback.htm> for detailed recycling information in different regions.

Ecodesign Directive

The European Union announced a framework for the setting of ecodesign requirements for energy-related products (2009/125/EC). Specific implementing measures are aimed at improving environmental performance of specific products or across multiple product types. ASUS provides product information at <https://esg.asus.com/Compliance.htm>.

低功率電波輻射性電機管理辦法

第十二條：經型式認證合格之低功率射頻電機，非經許可，公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計之特性及功能。

第十四條：低功率射頻電機之使用不得影響飛航安全及干擾合法通信；經發現有干擾現象時，應立即停用，並改善至無干擾時方得繼續使用。

Taiwan NCC Warning Statement

Article 12: Without permission, any company, firm or user shall not alter the frequency, increase the power, or change the characteristic and functions of the original design of the certified lower power frequency electric machinery.

Article 14: The application of lower power frequency electric machineries shall not affect the navigation safety nor interfere alegal communication, if an interference is found, the service will be suspended until improvement is made and theinterference no longer exists.

「產品之限用物質含有情況」之相關資訊，請參考下表：
Taiwan Declaration of Restricted Substances Marking

單元 (Unit)	限用物質及其化學符號 (Restricted substances and its chemical symbols)					
	鉛 Lead (Pb)	汞 Mercury (Hg)	鎘 Cadium (Cd)	六價鉻 Hexavalent chromium (Cr ⁶⁺)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyls ethers (PBDE)
印刷電路板 及電子組件 PCB	—	○	○	○	○	○
外殼 Chassis	—	○	○	○	○	○
硬碟 Disk drive	—	○	○	○	○	○
散熱設備 Thermal solutions	—	○	○	○	○	○
其他及其 配件 (線材等) Accessories (e.g., cables)	—	○	○	○	○	○
備考 1. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。						
備考 2. “—” 係指該項限用物質為排除項目。						
Note 1 “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.						
Note 2 The “—” indicates that the restricted substance corresponds to the exemption.						

A.5 Patents and trademarks

HDMI Trademark Notice

The terms HDMI, HDMI High-Definition Multimedia Interface, HDMI trade dress, and the HDMI Logos are trademarks or registered trademarks of HDMI Licensing Administrator, Inc.

A.6 Service and Support

Visit our multi-language website at <https://www.asus.com/support/>.

